

General Description

The MAX4634 fast, low-voltage, 4-channel CMOS analog multiplexer features 4Ω (max) on-resistance (RON). It offers Ron matching between switches to 0.3Ω (max) and Ron flatness of 1Ω (max) over the specified signal range. Each switch can handle V+ to GND analog signals. Off-leakage current is only 0.1nA (max) at +25°C. The MAX4634 features fast turn-on (ton) and turn-off (toff) times of 18ns and 11ns, respectively. All this comes in the tiny 10-pin µMAX® and 10-pin, 3mm x 3mm, TDFN packages.

This low-voltage multiplexer operates from a +1.8V to +5.5V single supply. All digital inputs have +0.8V and +2.4V logic thresholds, ensuring TTL/CMOS-logic compatibility with +5V operation.

Applications

Battery-Operated Equipment Audio and Video Signal Routing Low-Voltage Data-Acquisition Systems Sample-and-Hold Circuits Communications Circuits

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Features

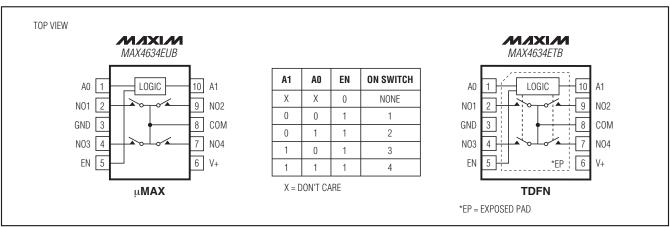
- **♦** Guaranteed R_{ON} 2.5 Ω (typ) with 5V Supply 4.5 Ω (typ) with 3V Supply
- ♦ 0.3Ω (max) Guaranteed Ron Match Between Channels
- ♦ 1Ω (max) Guaranteed Ron Flatness Over Signal Range
- ♦ 0.1nA (at +25°C) Guaranteed Low Leakage Currents
- ♦ +1.8V to +5.5V Single-Supply Operation
- ♦ +1.8V Operation $R_{ON} = 30\Omega$ (typ) Overtemperature ton = 30ns (typ), toff = 13ns (typ)
- ♦ V+ to GND Signal Handling
- ◆ TTL/CMOS-Logic Compatible
- ◆ -78dB Crosstalk (at 1MHz)
- ◆ -80dB Off-Isolation (at 1MHz)
- ♦ 0.018% Total Harmonic Distortion

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX4634EUB	-40°C to +85°C	10 μMAX	_
MAX4634ETB	-40°C to +85°C	10 TDFN-EP* (3mm x 3mm)	AAU

^{*}EP = Exposed pad.

Pin Configurations/Functional Diagrams/Truth Table



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Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND.)	
V+	0.3V to +6V
A_, EN, COM, NO_ (Note 1)	0.3V to $(V+ + 0.3V)$
Continuous Current (all other pins)	±20mA
Continuous Current (COM, NO_)	±50mA
Peak Current (COM, NO_ pulsed at 1ms,	
10% duty cycle)	±100mA

Continuous Power Dissipation (T _A = 10-Pin µMAX (derate 4.1mW/°C a 10-Pin TDFN (derate 24.4mW/°C	above +70°C)330mW
Operating Temperature Range	
Storage Temperature Range	
Lead Temperature (soldering, 10s)	+300°C
Storage Temperature Range	1951m\

Note 1: Signals on NO_, COM, EN, or A_ exceeding V+ or GND are clamped by internal diodes. Limit forward diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Single +5V Supply

 $(V+=+4.5V \text{ to } +5.5V, V_{IH}=2.4V, V_{IL}=0.8V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+5V, T_A=+25^{\circ}\text{C}.)$ (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
ANALOG SWITCH	_ I	I		II.			I.	
Analog Signal Range	V _{COM} , V _{NO} _			0		V+	V	
On Desistance	V+ = 4.5V, T _A = +25°C	T _A = +25°C		2.5	4			
On-Resistance	Ron	$I_{COM} = 10 \text{mA},$ $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			4.5	Ω	
On-Resistance Match	4.0	V+ = 4.5V,	T _A = +25°C		0.1	0.3		
Between Channels (Notes 4, 5)	ΔRon	$I_{COM} = 10 \text{mA},$ $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			0.4).4	
On-Resistance Flatness	D=	V+ = 4.5V,	T _A = +25°C		0.75	1		
(Note 6)	RFLAT(ON)	ICOM = 10mA, $V_{NO} = 0 \text{ to V} +$	TA = TMIN to TMAX			1.2	Ω	
NO_ Off-Leakage	1	INO_(OFF) VCOM = 1V, 4.5V;	T _A = +25°C	-0.1	±0.01	+0.1	nA	
Current (Note 7)	INO_(OFF)		TA = TMIN to TMAX	-0.3		+0.3		
COM Off-Leakage Current	1	V+ = 5.5V;	T _A = +25°C	-0.1	±0.01	+0.1	A	
(Note 7)	ICOM(OFF)	$V_{COM} = 1V, 4.5V;$ $V_{NO} = 4.5V, 1V$	TA = TMIN to TMAX	-0.65		+0.65	nA	
COM On-Leakage Current (Note 7)	laarvarn	V+ = 5.5V; $V_{COM} = 1V, 4.5V;$	T _A = +25°C	-0.1	±0.01	+0.1	nA	
	ICOM(ON)	V _{NO} = 1V, 4.5V, or unconnected	$T_A = T_{MIN}$ to T_{MAX}	-0.65		+0.65		
DIGITAL I/O (A_, EN)		I		ı			1	
Input Logic-High	VIH			2.4			V	
Input Logic-Low	VIL					0.8	V	
Input Logic Current				-100	5	+100	nA	

ELECTRICAL CHARACTERISTICS—Single +5V Supply (continued)

 $(V+=+4.5V \text{ to } +5.5V, V_{IH}=2.4V, V_{IL}=0.8V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+5V, T_A=+25^{\circ}\text{C}$.) (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DYNAMIC							
Turn-On Time (Note 7)	ton	$V_{NO} = 3V$, $R_L = 300\Omega$,	T _A = +25°C		14	18	ns
rum-on nine (Note 1)	tON	$C_L = 35pF$, Figure 2	TA = TMIN to TMAX			20	115
Turn-Off Time (Note 7)	toff	=	T _A = +25°C		6	11	ns
rum-on nine (Note 7)	iOFF	$R_L = 300\Omega$, $C_L = 35pF$, Figure 2	TA = TMIN to TMAX			13	115
Break-Before-Make Time	topu	$V_{NO} = 3V$, $R_L = 300\Omega$,	T _A = +25°C		8		ns
(Note 7)	†BBM	$C_L = 35pF$, Figure 3	TA = TMIN to TMAX	1			115
Charge Injection	Q	V _{GEN} = 2V, R _{GEN} = 0,	V _{GEN} = 2V, R _{GEN} = 0, C _L = 5pF, Figure 4		2		рС
Off Inclation (Note 9)	1/1	/ISO	f = 10MHz		-57		dB
Off-Isolation (Note 8)	VISO		f = 1MHz		-80		ub
O:t-II- (NI-t- O)	1/	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-52		-ID
Crosstalk (Note 9)	VCT	Figure 5	f = 1MHz		-78		dB
NO_ Off-Capacitance	C _{NO_(OFF)}	Figure 6			13		рF
COM Off-Capacitance	CCOM(OFF)	Figure 6			52		pF
COM On-Capacitance	CCOM(ON)	C _L = 5pF, Figure 6			68		pF
Total Harmonic Distortion	THD	$R_L = 600\Omega$, $f = 20Hz$ to $20kHz$			0.018		%
POWER SUPPLY							
Power-Supply Range	V+			1.8		5.5	V
Positive Supply Current	I+	V+ = 5.5V, V _{IH} = V+, V	/ _{IL} = 0		0.001	1.0	μΑ

ELECTRICAL CHARACTERISTICS—Single +3V Supply

 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=2.0V, V_{IL}=0.4V, T_A=-40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ Typical values are at $V+=+3V, T_A=+25^{\circ}C.)$ (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ANALOG SWITCH							
Analog Signal Range	VCOM, VNO_			0		V+	V
On-Resistance	Ron	V+ = 2.7V, ICOM = 10mA,	T _A = +25°C		4.5	7	Ω
Orr-nesistance	NON	$V_{NO} = 0$ to V+	$T_A = T_{MIN}$ to T_{MAX}			8	52
On-Resistance Match Between Channels	ΔRon	V+ = 2.7V,	T _A = +25°C		0.1	0.3	Ω
(Notes 4, 5)	Anon	$I_{COM} = 10mA,$ $V_{NO} = 0 \text{ to } V+$	$T_A = T_{MIN}$ to T_{MAX}			0.4	52

ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=2.0V, V_{IL}=0.4V, T_A=-40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $V+=+3V, T_A=+25^{\circ}\text{C}.)$ (Notes 2, 3)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
On-Resistance Flatness	RFLAT(ON)	V+ = 2.7V, ICOM = 10mA,	T _A = +25°C		1.2	2.5	Ω	
(Note 6)	1.11 [7.11(014)	$V_{NO} = 0$ to V_{+}	TA = TMIN to TMAX			3		
NO_ Off-Leakage Current	NO (OFF)	V+ = 3.3V; V _{COM} = 1V, 3V;	T _A = +25°C	-0.1	±0.01	+0.1	nA	
(Note 7)	INO_(OFF)	$V_{NO} = 3V, 1V$	$T_A = T_{MIN}$ to T_{MAX}	-0.3		+0.3	I IIA	
COM Off-Leakage Current	loor worsy	V + = 3.3V; $V_{COM} = 1V, 3V;$	T _A = +25°C	-0.1	±0.01	+0.1	nA	
(Note 7)	ICOM(OFF)	V _{NO} = 1V, 3V, V _{NO} = 3V, 1V	TA = TMIN to TMAX	-0.65		+0.65	1 IIA	
COM On-Leakage Current	laarvarii	V+ = 3.3V; V _{COM} = 1V, 3V;	T _A = +25°C	-0.1	±0.01	+0.1	n ^	
(Note 7)	ICOM(ON)	V _{NO} _ = 1V, 3V, or unconnected	TA = TMIN to TMAX	-0.65		+0.65	- nA	
DIGITAL I/O (A_, EN)		1		-				
Input High	VIH			2.0			V	
Input Low	VIL					0.4	V	
Input Logic Current				-100	5	+100	nA	
DYNAMIC				•				
Turn-On Time (Note 7)	ton	ton	V _{NO} _ = 2V, C _I = 35pF,	T _A = +25°C		16	22	ns
rum-on nine (Note 1)	TON	$R_L = 300\Omega$, Figure 2	$T_A = T_{MIN}$ to T_{MAX}			24	1 115	
Turn-Off Time (Note 7)	torr	V _{NO} _ = 2V, C _L = 35pF,	T _A = +25°C		8	14	ns	
rum-on rime (Note 1)		$R_L = 300\Omega$, Figure 2	$T_A = T_{MIN}$ to T_{MAX}			16	113	
Break-Before-Make Time	t _{BBM}	V _{NO} _ = 2V,	T _A = +25°C		9		ns	
(Note 7)	IBBM	$C_L = 35pF,$ $R_L = 300\Omega,$ Figure 3	TA = TMIN to TMAX	1			1 115	
Charge Injection	Q	V _{GEN} = 1.5V, R _{GEN} =	0, C _L = 5pF, Figure 4		2		рС	
Off-Isolation (Note 8)	VISO	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-57		dB	
On-isolation (Note o)	V15U	Figure 5	f = 1MHz		-80		1 UD	
Crosstalk (Note 9)	VcT	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-52		- dB	
Grossian (rivoto o)	VC1	Figure 5	f = 1MHz		-78		UD	

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ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

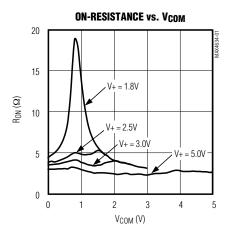
 $(V+=+2.7V \text{ to } +3.3V, V_{IH}=2.0V, V_{IL}=0.4V, T_A=-40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ Typical values are at $V+=+3V, T_A=+25^{\circ}C.$) (Notes 2, 3)

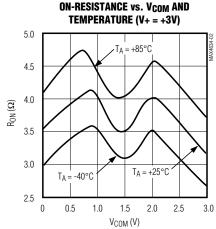
PARAMETER	SYMBOL	CONDITIONS MIN TYP MAX		MAX	UNITS	
NO_ Off-Capacitance	CNO_(OFF)	V_{NO} = GND, f = 1MHz, Figure 6			рF	
COM Off-Capacitance	CCOM(OFF)	$V_{COM} = GND, f = 1MHz, Figure 6$ 52			рF	
COM On-Capacitance	C _(ON)	V _{COM} = V _{NO} = GND, f = 1MHz, Figure 6		68		pF
Total Harmonic Distortion	THD	$R_L = 600\Omega$, $f = 20$ Hz to 20kHz 0.018			%	
POWER SUPPLY			•			
Positive Supply Current	l+	$V+ = 3.3V$, $V_{IH} = V+$, $V_{IL} = 0$		0.001	1	μΑ

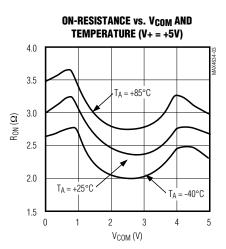
- **Note 2:** The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.
- Note 3: TDFN parts are tested at +25°C and guaranteed by design and correlation over the entire temperature range.
- **Note 4:** $\Delta R_{ON} = R_{ON(MAX)} R_{ON(MIN)}$.
- **Note 5:** R_{ON} and ΔR_{ON} matching specifications for TDFN-packaged parts are guaranteed by design.
- **Note 6:** Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
- Note 7: Guaranteed by design.
- **Note 8:** Off-isolation = $20\log_{10}$ (V_{COM} / V_{NO}), where V_{COM} = output and V_{NO} = input to off switch.
- Note 9: Between any two switches.

Typical Operating Characteristics

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

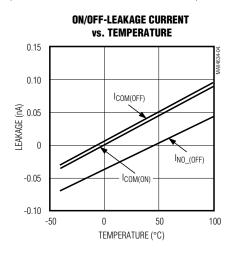


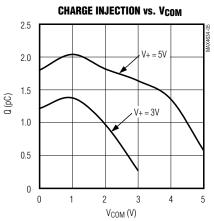


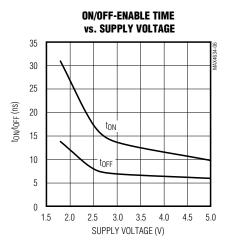


_Typical Operating Characteristics (continued)

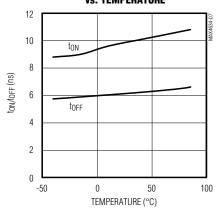
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$



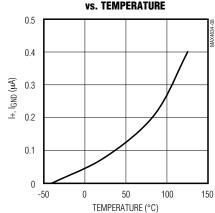




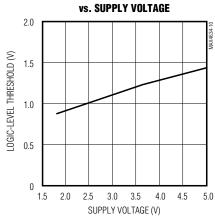
ON/OFF-ENABLE TIME vs. TEMPERATURE



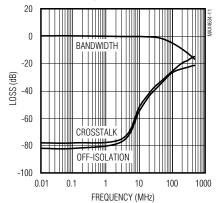




LOGIC-LEVEL THRESHOLD



FREQUENCY RESPONSE



Pin Description

PIN		
μMAX/ TDFN	NAME	FUNCTION
1	AO	Address Input. See the <i>Truth Table</i> for details.
2	NO1	Normally Open Switch 1
3	GND	Ground
4	NO3	Normally Open Switch 3
5	EN	Enable Logic Input. See the <i>Truth Table</i> for details.
6	V+	Positive Supply Voltage. Connect to an external power supply. Bypass to GND with a 10µF capacitor placed as close to the pin as possible.
7	NO4	Normally Open Switch 4
8	COM	Analog Switch Common Terminal
9	NO2	Normally Open Switch 2
10	A1	Address Input. See the <i>Truth Table</i> for details.
_	EP	Exposed Pad. Internally connected to GND. Connect to a large PCB ground plane for proper operation. Not intended as an electrical connection point (TDFN package only).

Detailed Description

The MAX4634 is a low-on-resistance, low-voltage analog multiplexer that operates from a +1.8V to +5.5V single supply. CMOS switch construction allows processing of analog signals that are within the supply voltage range (GND to V+).

To disable all switch channels, drive EN low. All four inputs and COM become high impedance during this state. If the disable feature is not needed, connect EN to V+.

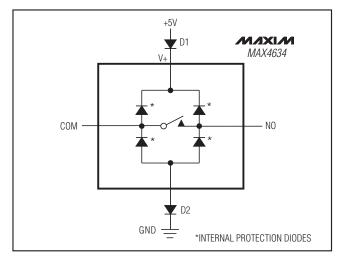


Figure 1. Overvoltage Protection Using External Blocking Diodes

Applications Information

Power-Supply Sequencing and Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V+ before applying analog signals or logic inputs, especially if the analog or logic signals are not current limited. If this sequencing is not possible, and if the analog or logic inputs are not current limited to < 20mA, add a small-signal diode (D1) as shown in Figure 1. If the analog signal can dip below GND, add D2. Adding protection diodes reduces the analog signal range to a diode drop (about 0.7V) below V+ for D1 or to a diode drop above ground for D2. The addition of diodes does not affect leakage. On-resistance increases by a small amount at low supply voltages. Maximum supply voltage (V+) must not exceed 6V.

Protection diodes D1 and D2 also protect against some overvoltage situations. A fault voltage up to the absolute maximum rating at an analog signal input does not damage the device, even if the supply voltage is below the signal voltage.

Test Circuits/Timing Diagrams

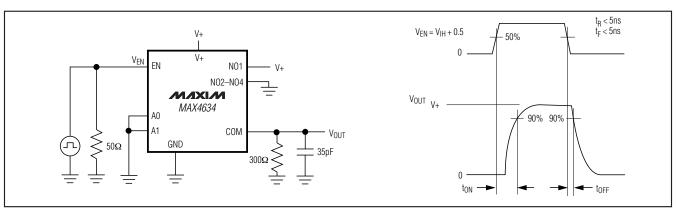


Figure 2. Switching Time

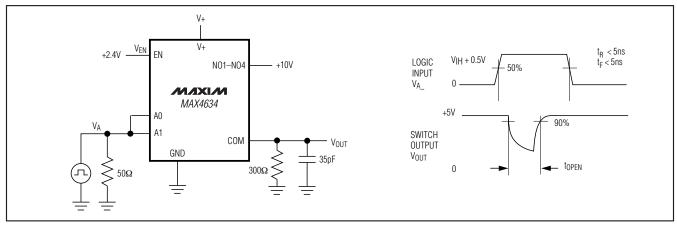


Figure 3. Break-Before-Make Interval

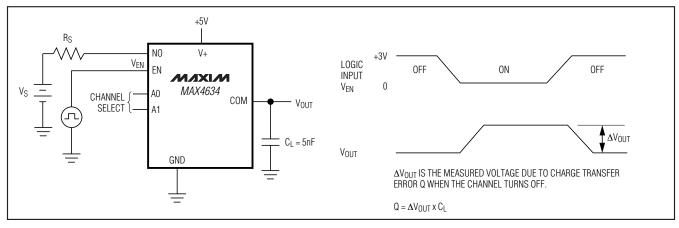


Figure 4. Charge Injection

Test Circuits/Timing Diagrams (continued)

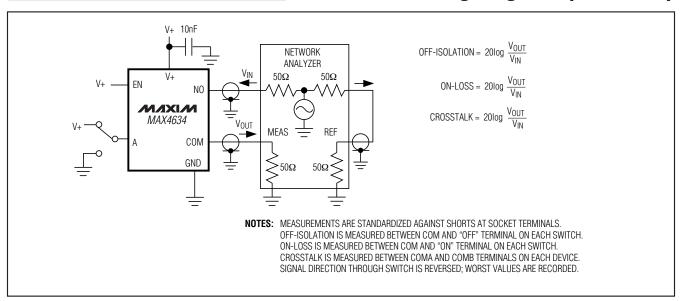


Figure 5. Off-Isolation/On-Channel Bandwidth

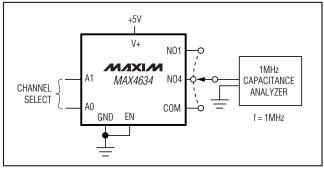


Figure 6. Channel Off/On-Capacitance

Chip Information

PROCESS: CMOS

_Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
10 μMAX	_	<u>21-0061</u>
10 TDFN	T1033-1	21-0137

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/00	Initial release	_
1	2/02	Added QFN package	_
2	5/03	Added QFN packaging information	_
3	2/09	Added TDFN package information (replaced QFN), style edits	1, 7

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